

**MAINTENANCE MANUAL
ORION™ (Dual Bandwidth)
UHF CONTROL LOGIC/IF BOARD
CMC-682/CMF-138**

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DESCRIPTION

The System Control Logic/IF circuit board combines functions of receive circuit 1st IF, 2nd IF, audio detection, audio signal processing and system control on one circuit board. As an option, an additional circuit board can be plugged into this board to provide **AEGIS™** (digital encryption system). Programming and personality information is stored in **FLASH** and **EPPROM** memory on the logic/IF board. The audio speaker amplifier is also part of the same board.

This board provides an electrical interface between the Control Unit (LCC), synthesizer, RF PA (APC) and the Option and Remote Control Connector (ORCC) on the rear of the assembled radio.

All radio control signals originate or terminate on the control logic/IF board. Two microcomputers share the processing load. Control signals are connected through a high speed digital link with the control unit, either through the LCC or ORCC connectors, making possible either front or remote control for the radio. The same link also makes possible dual radio or dual control head configuration. An RS-232 compatible digital link is available at the ORCC interface, to facilitate programming or Radio Data Interface to Mobile Digital terminals.

This circuit board also generates Type 99, Channel Guard, GE-Star and DTMF signals if so programmed.

The System Control Logic/IF board consists of the following control logic, IF and audio circuits (see figures 1 & 2).

SYSTEM CONTROL LOGIC (CMC-682)

- CMOS Microprocessor (IC701, IC702)
- Custom CMOS ASIC Chip (IC703)
- Address Decoder (IC704)
- RS-485 (IC705)
- RS-232 (IC706)
- Flash EEPROM (IC707)
- EEPROM (IC708)
- CMOS SRAM (IC709)
- CMOS Inverters (IC711)
- Silicon Serial Number (IC712)
- TTL Inverters (IC713)

IF (CMF-138)

- Custom CMOS ASP Chip (IC601)
- Operational Amplifier (IC602, IC603)
- Audio Amplifier (IC604)
- 5 Volt Regulator (IC606, IC607)
- 9 Volt Regulator (IC605, IC608, IC609)
- Reset Circuit (IC610)
- Bilateral Switch (IC611, IC612)

CIRCUIT ANALYSIS

LOGIC SECTION (CMC-682)

Microcomputer

The main microcomputer circuit in the **ORION** radio consist of microprocessor IC701, EEPROM IC708, Flash EEPROM IC707, RAM IC709 and custom ASIC IC703. This circuitry runs at a 9.8304 MHz rate determined by crystal X701 and controls the radio through a second microprocessor IC702. This second microprocessor runs at a 4.9152 MHz rate. The 4.9152 MHz rate is determined by ASIC IC703. The microcomputer circuit performs the following functions for the radio:

- Controlling the **ASIC**, **FLASH EEPROM** and **RAM**
- Loading data to the frequency synthesizer
- Fetching and processing the PTT, monitor, channel, selection and volume control
- Controlling the audio circuit (processor)
- Decoding the squelch
- Encoding/Decoding the Channel Guard and Digital Channel Guard
- Controlling the loading interface for the radio data (channel number and signaling)

FLASH EEPROM (IC707)

This memory contains the software to control the microprocessor. This Flash EEPROM has a storage capacity of 256k x 8 bits.

CMOS SRAM (IC709)

This SCRATCH RAM has a storage capacity of 32k x 8 bits. The memory is available for variables, buffers, etc.

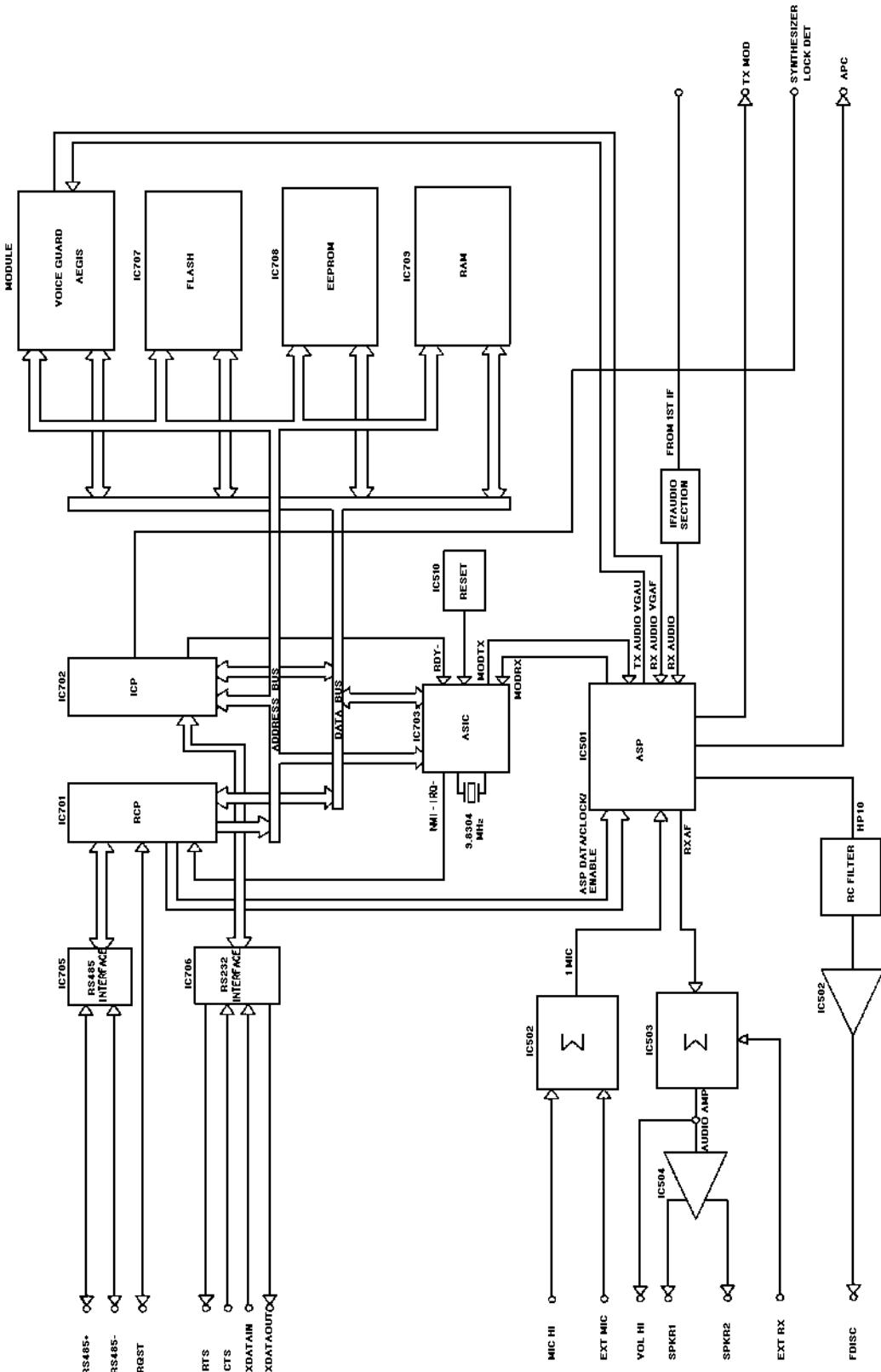


Figure 1 - Logic Section Block Diagram

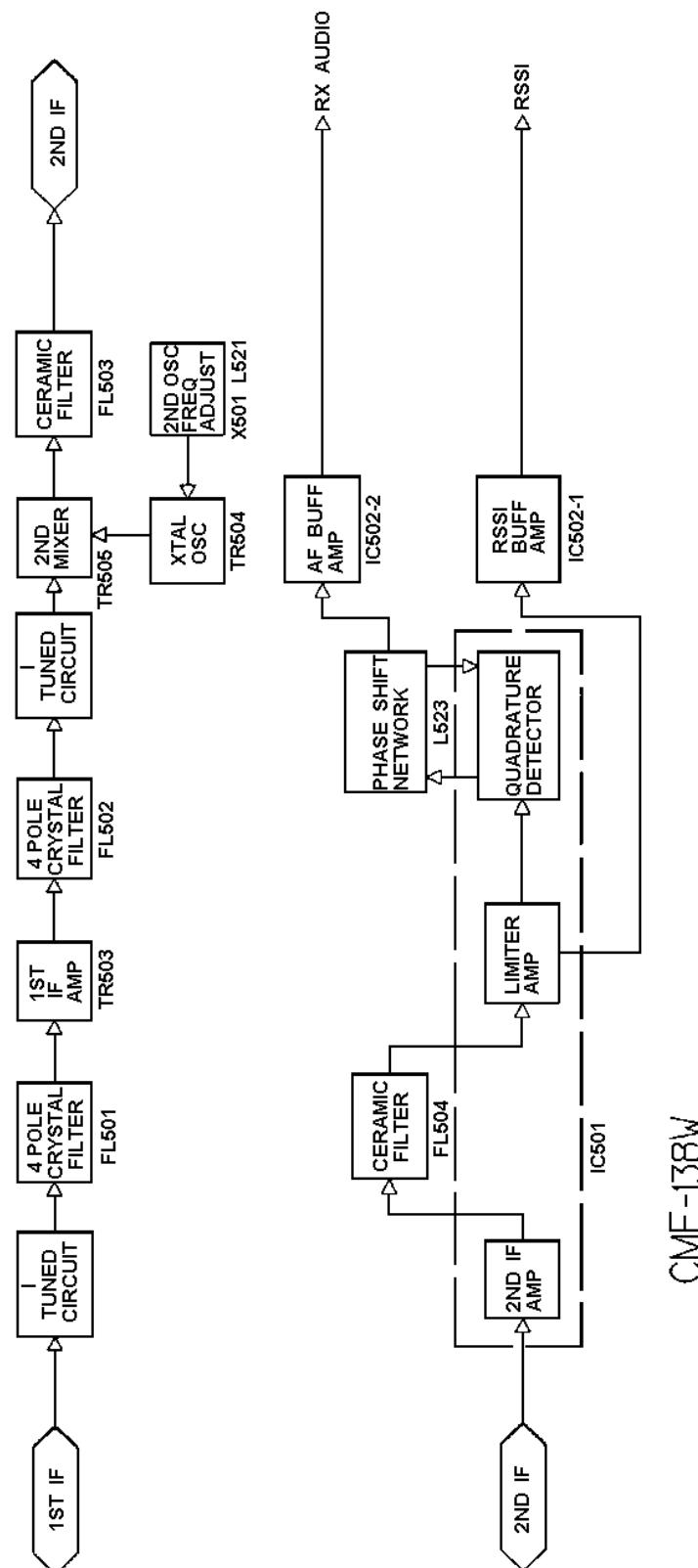


Figure 2 - IF Section Block Diagram

EEPROM (IC708)

This EEPROM has a storage capacity of 8k x 8 bits. The memory contains the user configurable parameters that must be maintained through a power cycle. This personality controls various functions of the radio. The personality data is entered from outside the radio through the ORCC connector to the microprocessor and then to the EEPROM.

The data mainly consists of the following:

- Channel Frequency Data
- CG/DCG Data
- Tx Power, Tx MODulation Data
- Squelch Data
- Display Data, etc.

APPLICATION OF SPECIFIC INTEGRATED CIRCUITS

ASIC (IC703)

The ASIC chip integrates many miscellaneous tasks by providing the following functions:

- MODEM
- Watch Dog Timer
- Clock Control
- Interrupt Control
- Address Decode etc.

Voltage Regulators (IC606, IC607) (IC605, IC608, IC609)

Voltage regulators IC606 and IC607 each generate a 5 Vdc for the Control Board. Voltage regulators IC605, IC608 and IC609 each generate a 9 Vdc for the Control Board and Voice Guard Adapter Module.

Audio Amplifier (IC604)

The audio amplifier is located between the audio processor and the speaker. Amplifier IC604 amplifies the output signal of the ASP (IC601) to the level adequate for driving the speaker.

Audio Signal Processor (ASP) (IC601)

The audio process consists of a one-chip IC accommodating almost all of the audio functions. The audio functions are

under control of the microcomputer in compliance with the function of the radio unit.

The functions of the audio processor are as follows:

- Rx Audio process with Tone Reject Filter, De-emphasis and Programmable Attenuator.
- Data Limiting
- CG/DCG filtering and limiting
- Noise Squelch filtering and detecting
- 8 bits D/A Converter with sample and hold
- Tx audio process with microphone amplifier, pre-emphasis, deviation limiter, summing amplifier, post limiter filter and programmable attenuator
- Data signal filtering
- Two 6 bits programmable divider for clock and alert tone

All of these functions are made up of switched capacitor filters, amplifiers and timing logic. The timing for this logic is derived from the 4.9152 MHz clock generator (ASIC).

RS-485 (IC705)

This is a high speed differential TRI-STATE bus/line transceiver designed to meet the requirements of EIA standard RS-485 specification. The IC705 is located between the Radio Unit and the Control Unit.

RS-232 (IC706)

This IC consists of line drivers/receivers designed to meet the requirements of EIA standard RS-232 specifications. The IC706 is located between the radio unit and the ORCC.

Reset Circuit (IC610)

This is an active low reset IC which includes a delay time generating circuit. Delay time can be set up by externally using a capacitor and a resistor. The function of this IC is to accurately reset the system after detecting voltage at the time of switching power on and instantaneous power off.

Option and Remote Control Connector (ORCC)

The ORCC is located on the rear of the radio and is used for options and accessories when Control Unit and Radio Unit are directly attached and for remote control in all other configurations. The ORCC allows various kinds of external equipment connections to be made. External equipment connecting signals are as follows:

Linear, IF Amplifier/Detector IC501

PIN	SIGNAL	PIN	SIGNAL
1	SUP GND	20	RTS
2	XDATA IN	21	INP1
3	XDATA OUT	22	OUT1
4	RS485+	23	INP2
5	RS485-	24	IGN A+
6	CTS	25	SW +
7	GND	26	HKSW
8	FPROG	27	EXTMIC
9	OUT2	28	EXTRX
10	IGN SEN	29	FDISC
11	MIC HI	30	EXTALO
12	ALO	31	CUTST
13	VOL HI	32	SPARE
14	CTL ON	33	SPARE
15	XTONEENC	34	SPARE
16	XTONEDEC	35	SDATA
17	RQST	36	SONOFF
18	SPKR1	37	HORNRING
19	SPKR2		

IF SECTION (CMF-138)**1st IF**

The 82.2 MHz 1st IF output signal is coupled from the output of the first mixer circuit, located on the Synthesizer/Receiver/IF board, through 30-pin connector P501-1 and capacitor C501 to the source input of buffer amplifier Junction Field Effect Transistors (JFET) TR501 and TR502. This input can be monitored at test point TP1. The output of TR501 and TR502 is coupled through inductor L502 to 4-pole crystal band-pass filter FL501. The highly-selective crystal filters FL501-1 and FL502-2 provide the first part of receiver IF selectivity. The output of the filters is coupled through the impedance matching network consisting of inductor L502 and capacitors C504 and C505 to the base of 1st IF amplifier transistor TR503.

The crystal filter output of FL501 is applied to the base of 1st IF amplifier transistor TR503. This amplified signal is taken from the collector of TR503 through an impedance matching network consisting inductor L505, capacitor C506 and resistor R507 that matches the amplifier output to the input of 4-pole crystal filters FL502-1 and FL502-2 which provides the second part of receiver IF selectivity. The output of the crystal filters is coupled through an impedance-matching network consisting of inductor L507, capacitor C508, resistor R508 and coupling capacitor C509 to the base of 2nd IF amplifier transistor TR505.

2nd Mixer

The 82.2 MHz IF input is applied to transistor TR505 and mixed with a 82.655 MHz frequency supplied by a crystal os-

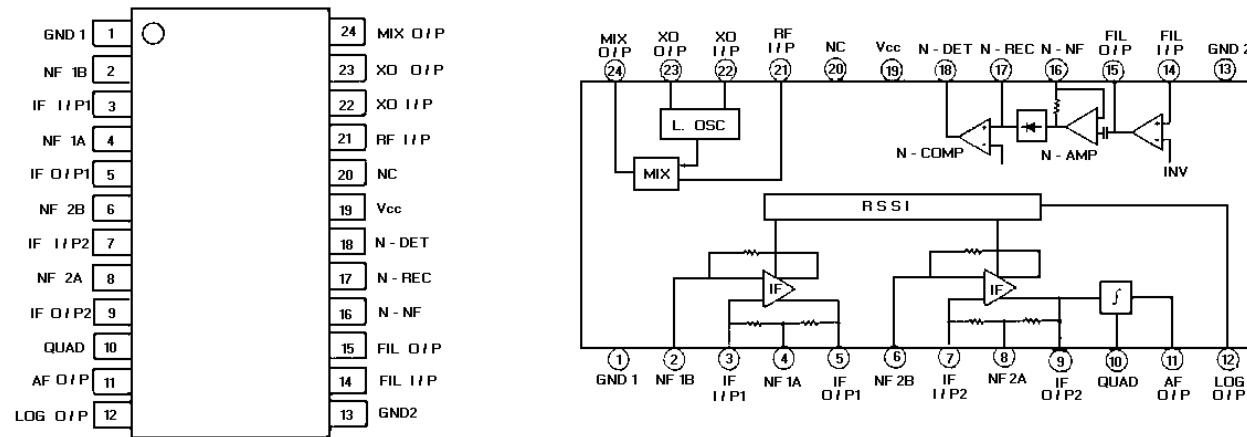
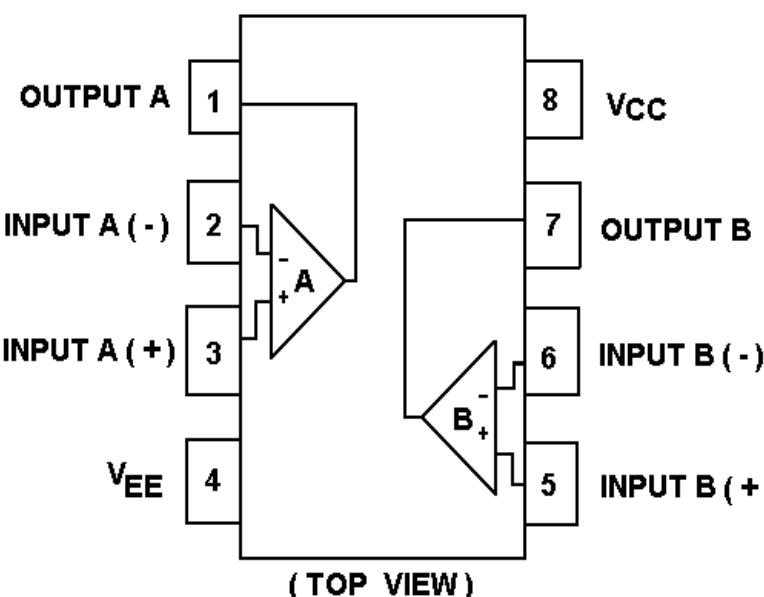
cillator circuit consisting of X501 and oscillator transistor TR504. Variable inductor L521 sets the frequency of the oscillator circuit. This signal can be monitored at test point TP5.

2nd IF And Detector

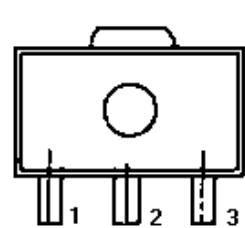
The output of the 2nd mixer is coupled to the input of 4-pole ceramic filter FL503 which provides 455 kHz 2nd IF selectivity. The 455 kHz IF output of ceramic filter FL503 is coupled to the bandwidth selector circuit, which consists of IC504-1, IC504-2, IC505-1 and IC505-2 which are controlled by a microprocessor output signal 12.5 kHz/ 25 kHz through switching transistor TR506 and TR507. When 25 kHz (wide band) is selected, IC504-1 and IC505-1 are turned on. The output of the ceramic filter FL503 is coupled through capacitors C580 and C553 to the input of IC501, pin 3. When 12.5 kHz (narrow band) is selected, IC504-2 and IC505-2 are turned on. The output of the ceramic filter FL503 is coupled through 4-pole ceramic filter FL505 to pin 3 Limiter/FM Detector IC501. The IF signal is amplified internal to IC501 then applied to the bandwidth selector circuit consisting of IC506-1, IC506-2, IC507-1 and IC507-2. The bandwidth selector is controlled by a microprocessor output signal 12.5 kHz/ 25 kHz through switching transistor TR506 and TR507. When 25 kHz (wide band) is selected, IC506-1 and IC507-1 are turned on. The output of the IC501-5 is coupled through ceramic filter FL504 which provides additional 455 kHz IF selectively to the input of IC501, pin 7. When 12.5 kHz (narrow band) is selected, IC504-2 and IC505-2 are turned on. The output of the IC501-5 is coupled through ceramic filter FL506 which provides additional 455 kHz IF selectively to the input of IC501, pin 7 (refer to IC DATA for IC501). The 2nd IF signal is amplified and limited internal to IC501. Inductor L253 shifts the IF signal by 90° and applies it to the internal FM detector. The FM detector compares the shifted IF signal to the internal IF signal to recover the audio modulation. The audio output of the operational amplifier internal to IC501 is applied the input of buffer IC502-2. The amplitude of buffer amplifier IC502-2 is reduced by 6 dB when 25 kHz (wide band) is selected by switching transistor TR508. The AUDIO output of IC502-2 is applied to the System Control Logic circuit. This signal can be monitored at test point TP4. The output on pin 12 of IC501 is applied to the input of amplifier buffer IC502-1. The output of IC502-1 provides a Receiver Signal Strength Indicator (RSSI) signal that is also sent to the System Control Logic circuit. This signal can be monitored at test point TP2.

9 Volt Regulator

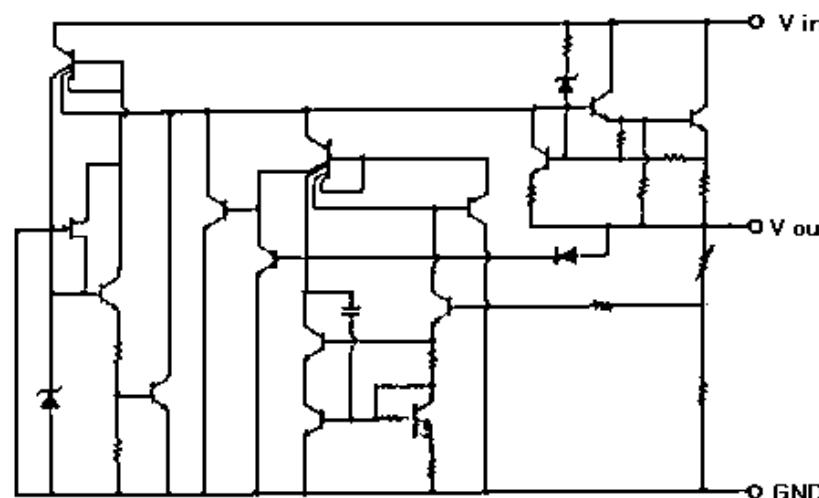
The 9-volt regulator circuit powers the IF circuits of CMF-138 and consists of regulator IC503 and filter capacitors C570, C571, C572, and C573. An input voltage of +13.8 Vdc is applied to the input of IC503. This input is monitored at test point TP2.

**Linear, Dual Operational Amplifier IC502**

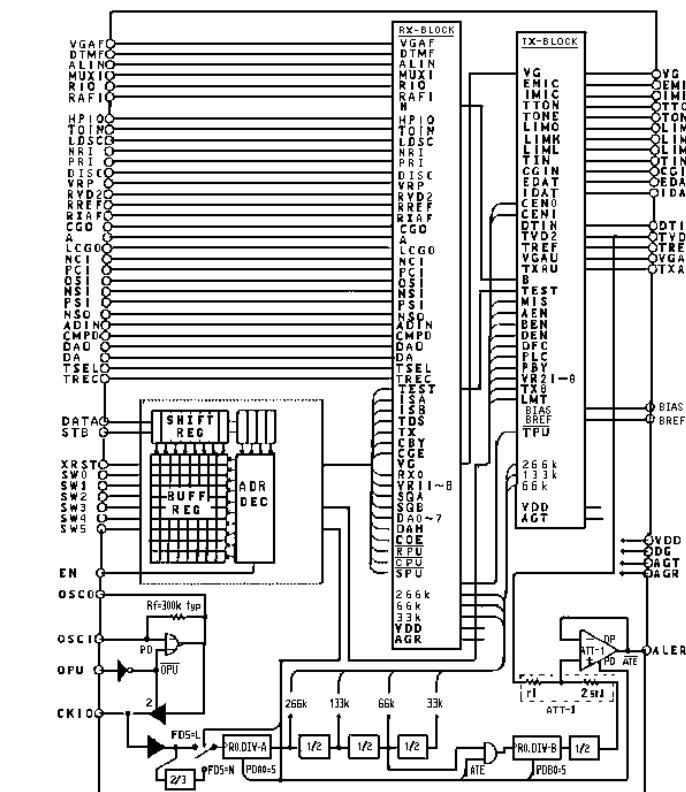
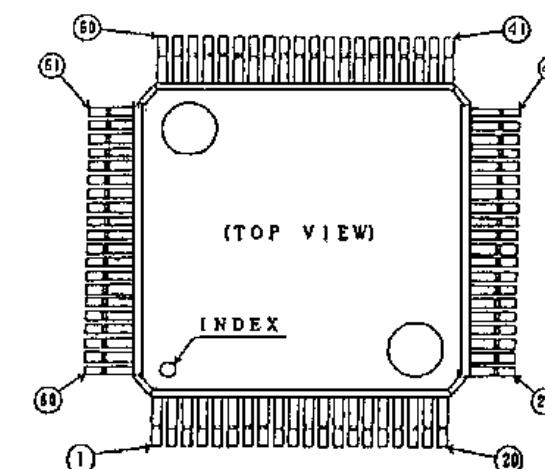
Linear, Positive Voltage Regulator IC503



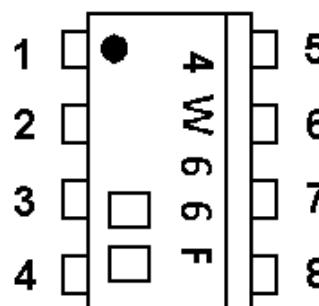
1. OUT
2. GND
3. IN



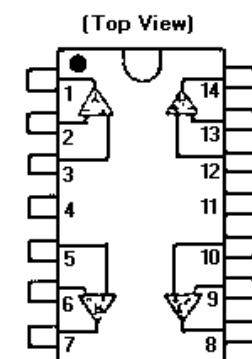
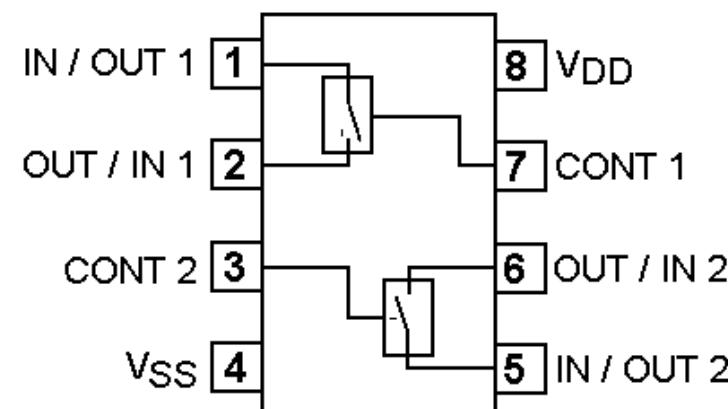
Audio Signal Processor IC601



Circuit IC504 - IC507

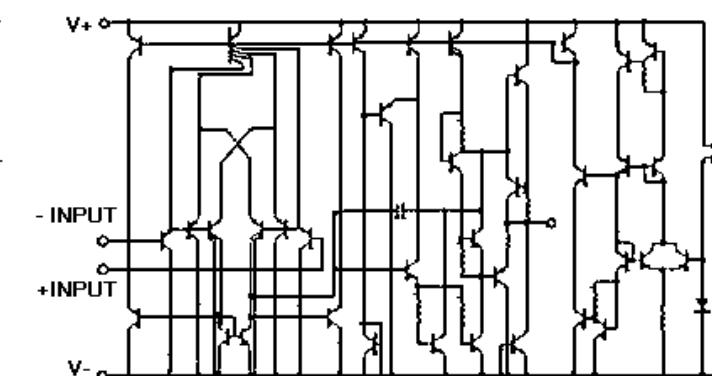


1. IN / OUT 1
2. OUT / IN 1
3. CONT 2
4. VSS
5. IN / OUT 2
6. OUT / IN 2
7. CONT 1
8. VDD

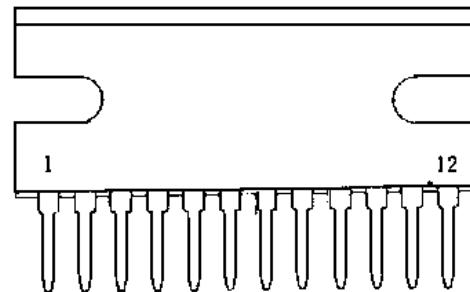


1. A OUTPUT	8. C OUTPUT
2. A - INPUT	9. C- INPUT
3. A + INPUT	10. C+INPUT
4. V+	11. V-
5. B+ INPUT	12. D+ INPUT
6. B- INPUT	13. D- INPUT
7. B OUTPUT	14. D OUTPUT

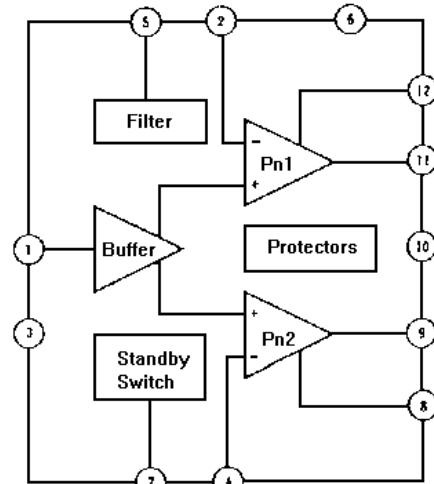
Linear Audio Amplifier IC602, IC603



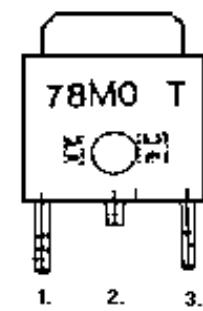
Audio Frequency Power Amplifier IC604



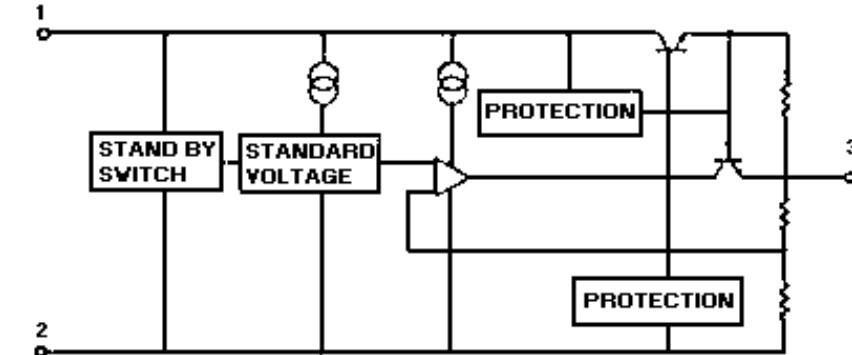
1. INPUT
2. NFB 1
3. GND(INPUT)
4. NFB 2
5. FILTER
6. VCC
7. STAND-BY SW
8. BOOTSTRAP 2
9. OUTPUT 2
10. GND(OUTPUT)
11. OUTPUT 1
12. BOOTSTRAP 1



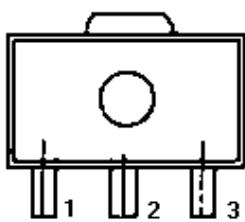
Linear: Positive Voltage Regulator IC607, IC608



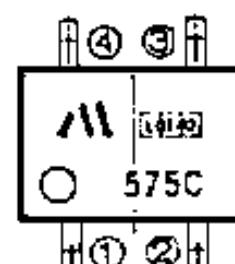
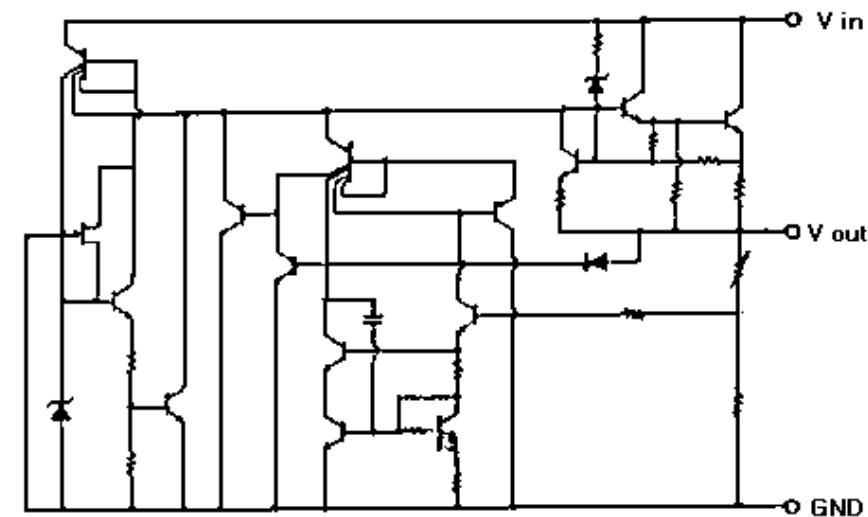
1. INPUT
2. GND
3. OUTPUT



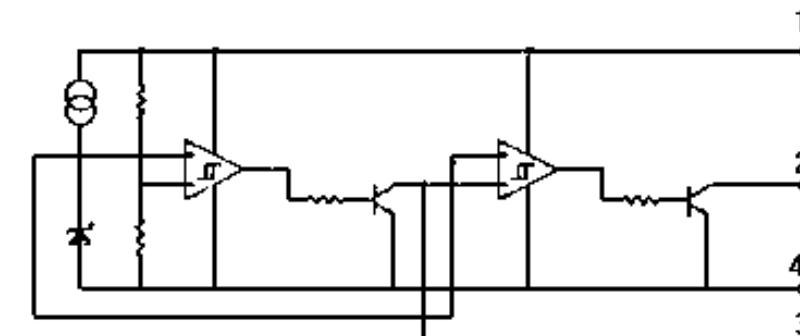
Linear: Positive Voltage Regulator IC605, IC609



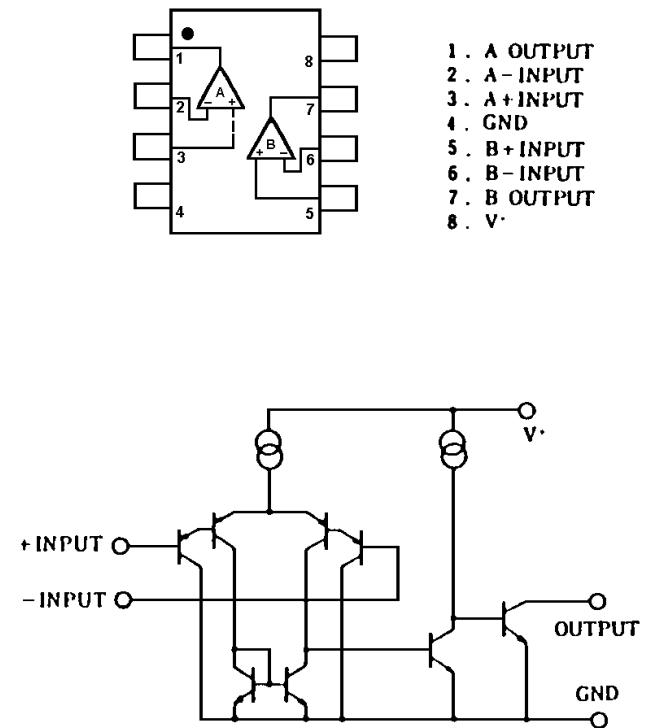
1. OUT
2. GND
3. IN



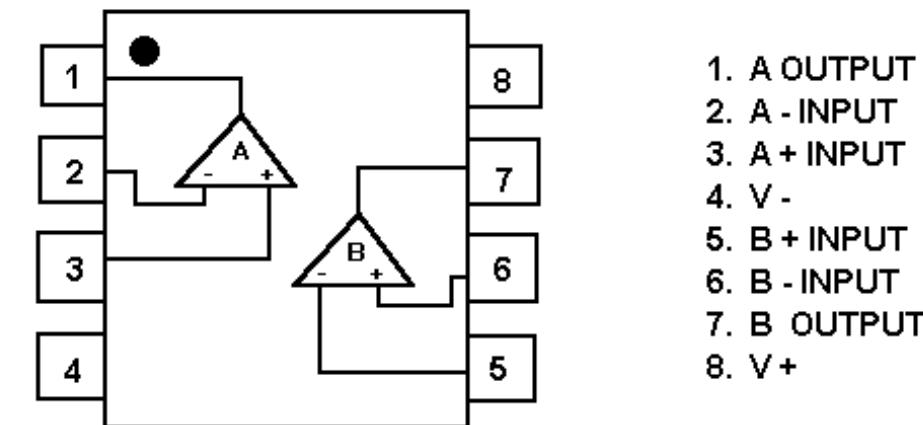
1. VCC
2. OUT
3. CO
4. GND



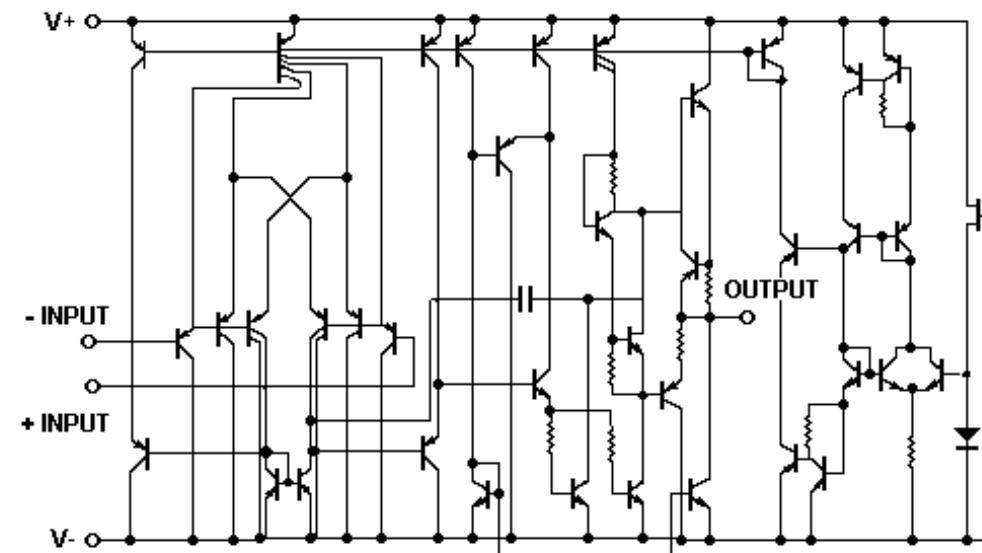
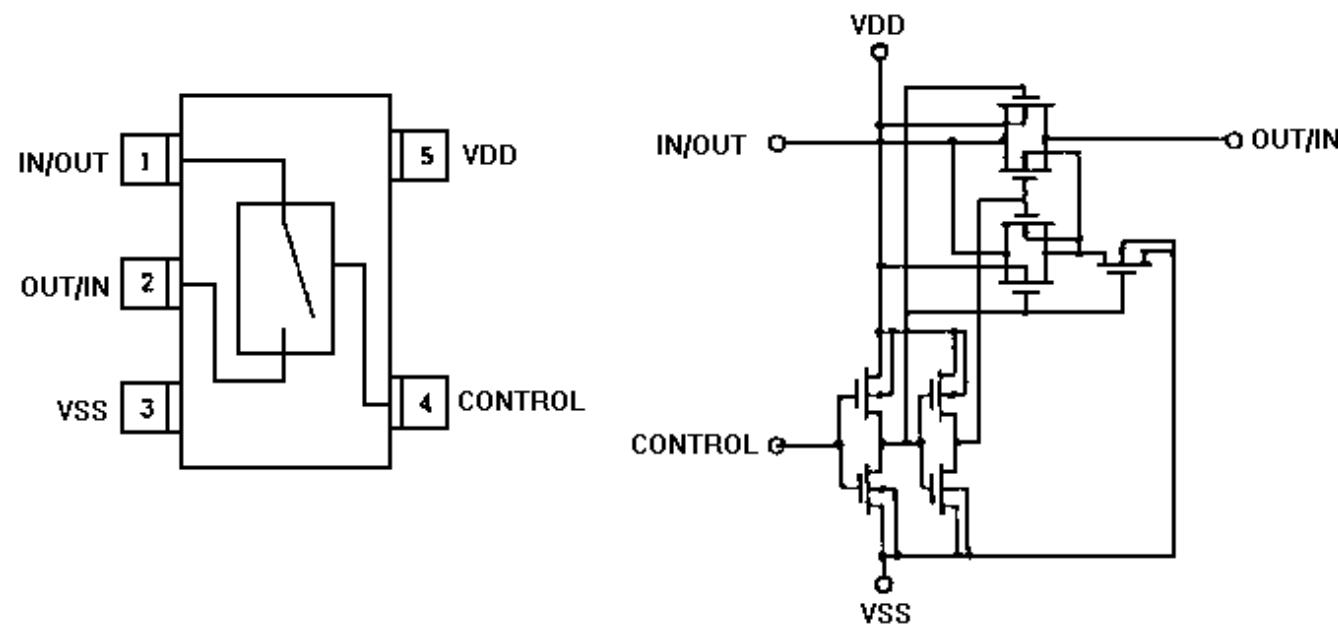
Reset Circuit IC610



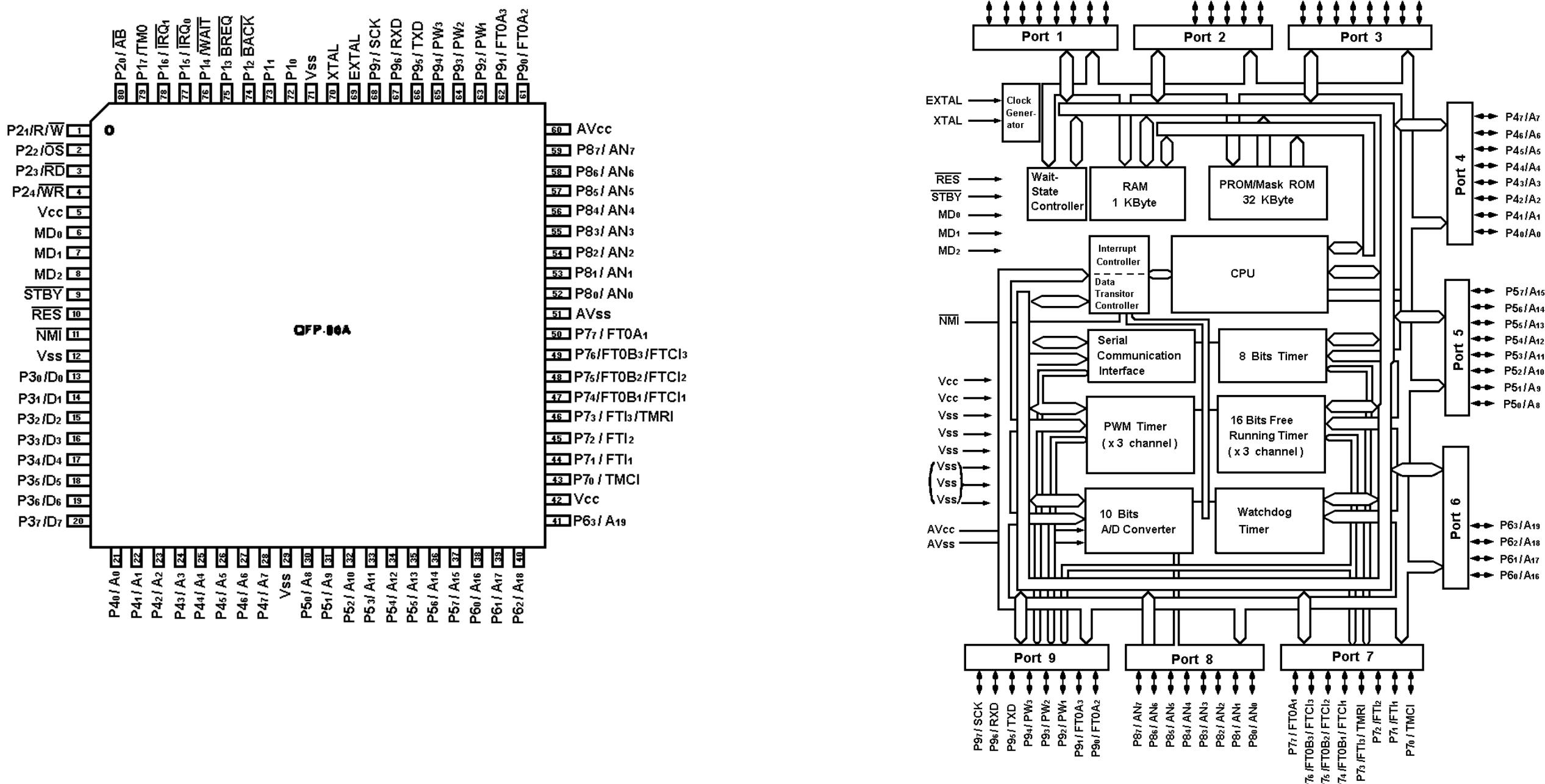
Circuit IC614



Bilateral Switch IC611, IC612, IC613

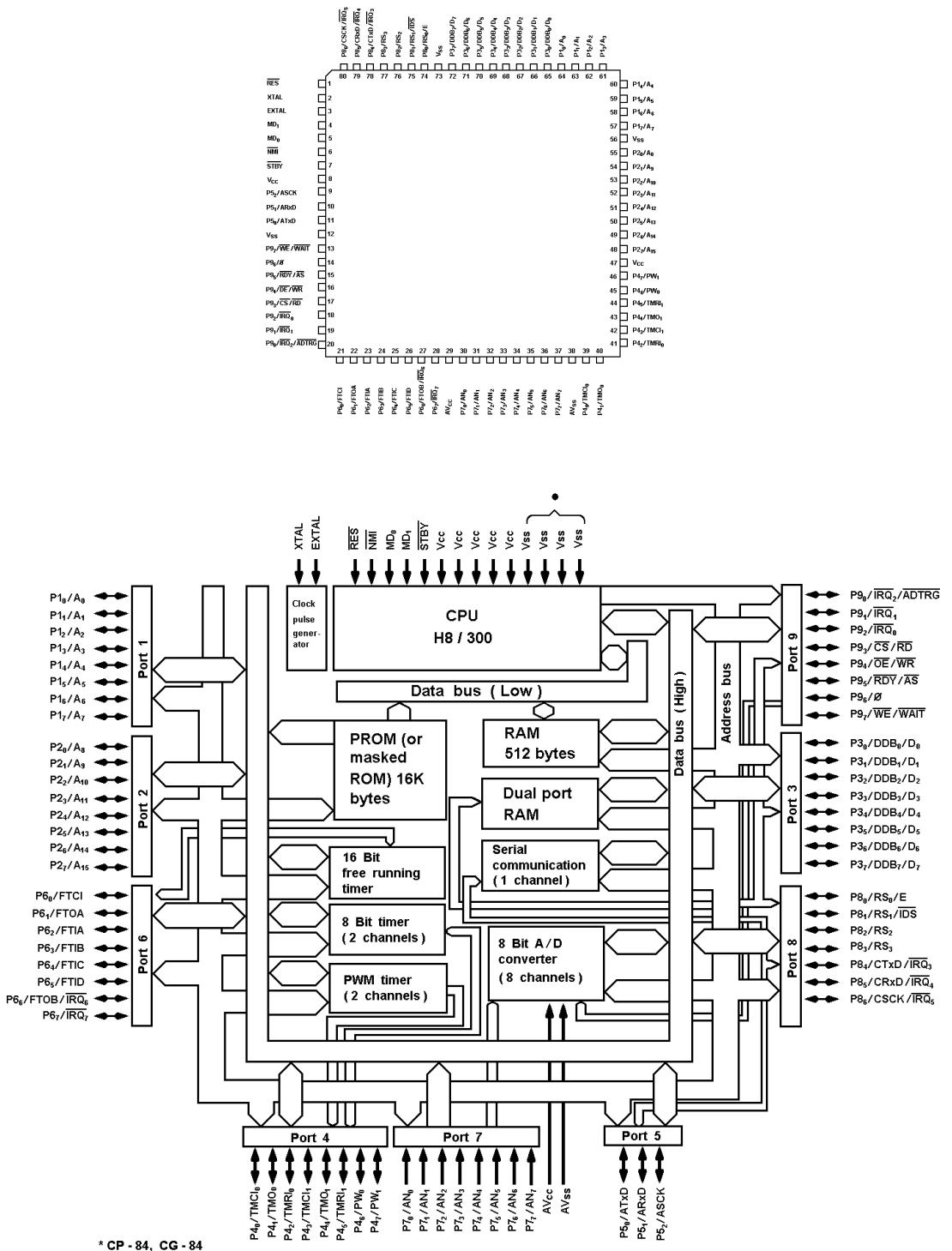


Central Processing Unit IC701

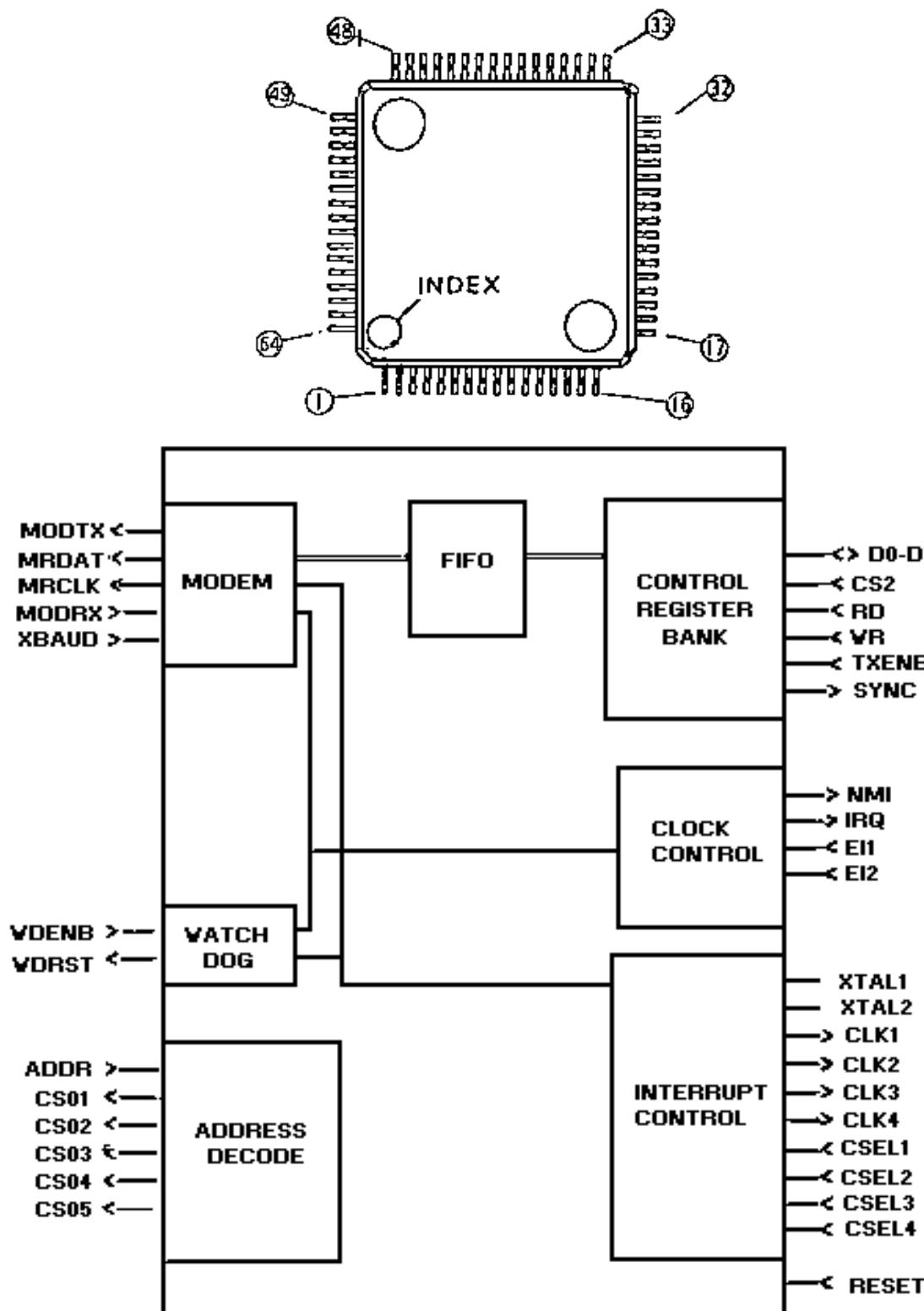


*CP-84 and CO-84 only

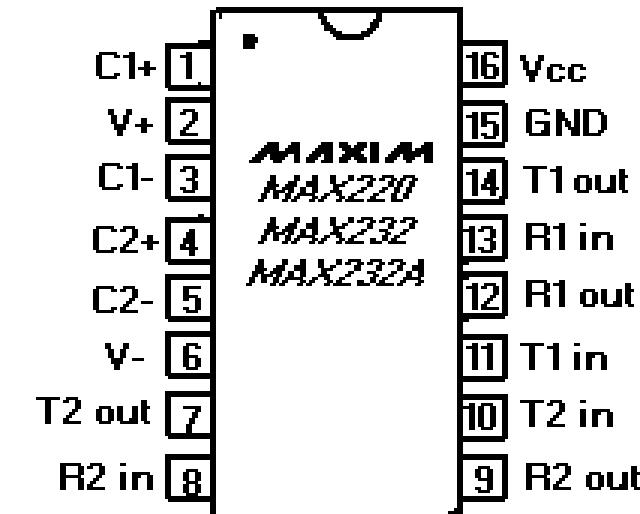
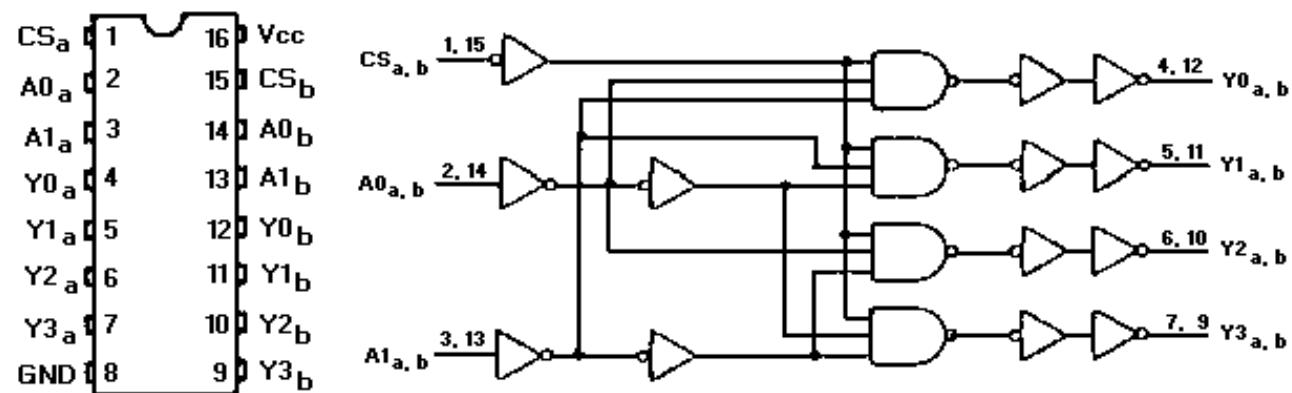
Central Processing Unit U702



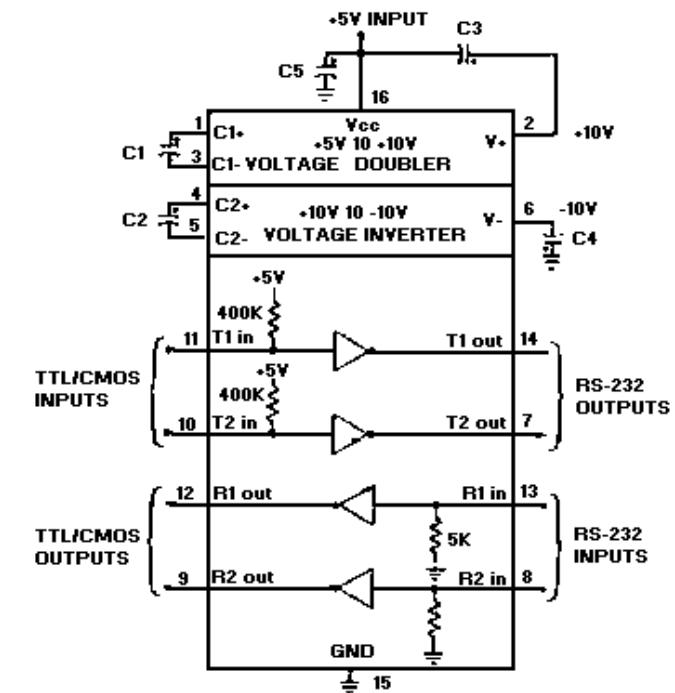
ASIC IC703



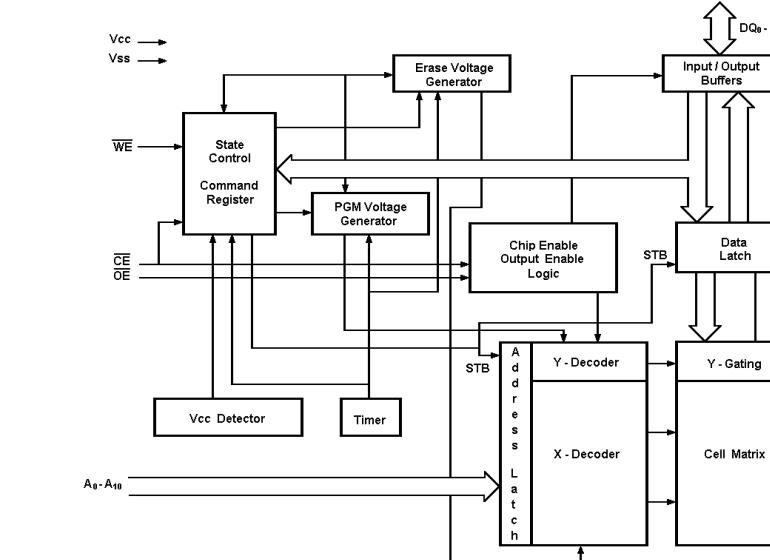
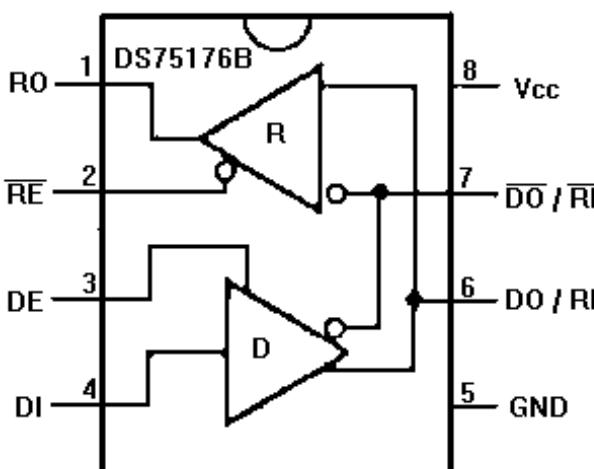
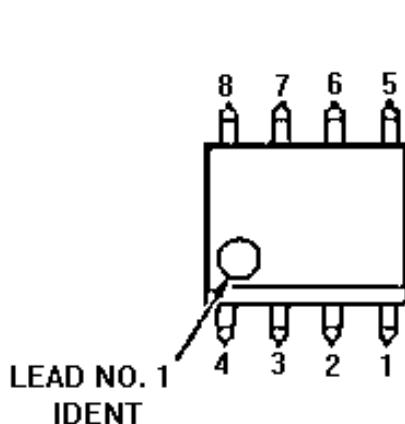
Decoder IC704



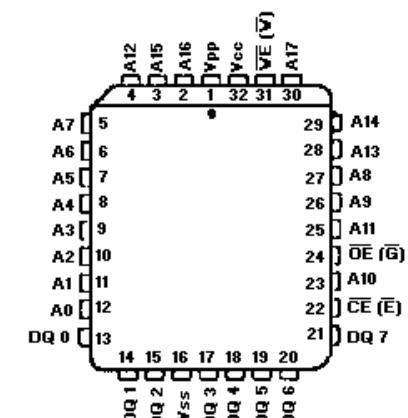
RS-232 Driver/Receiver IC706



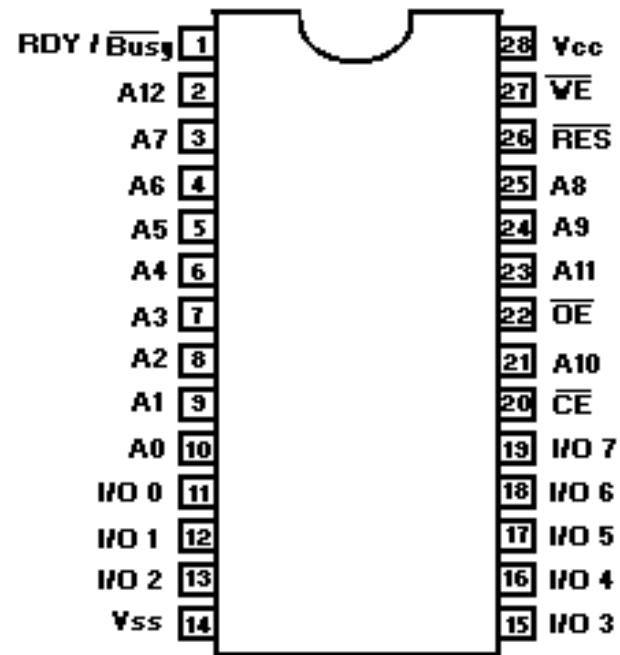
RS-485 Driver/Receiver IC705



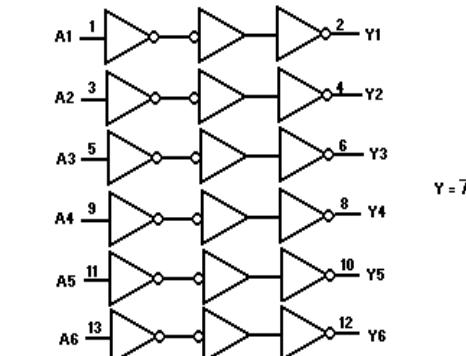
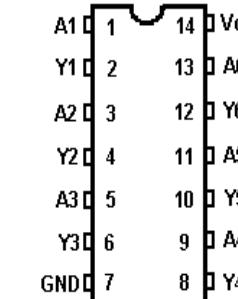
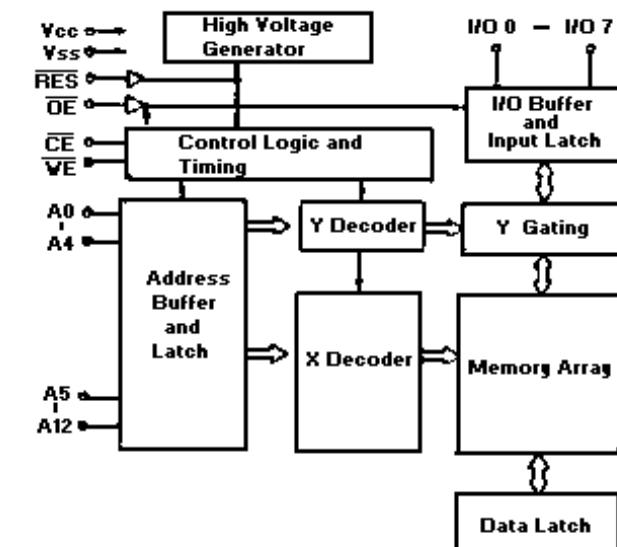
Flash Memory IC707



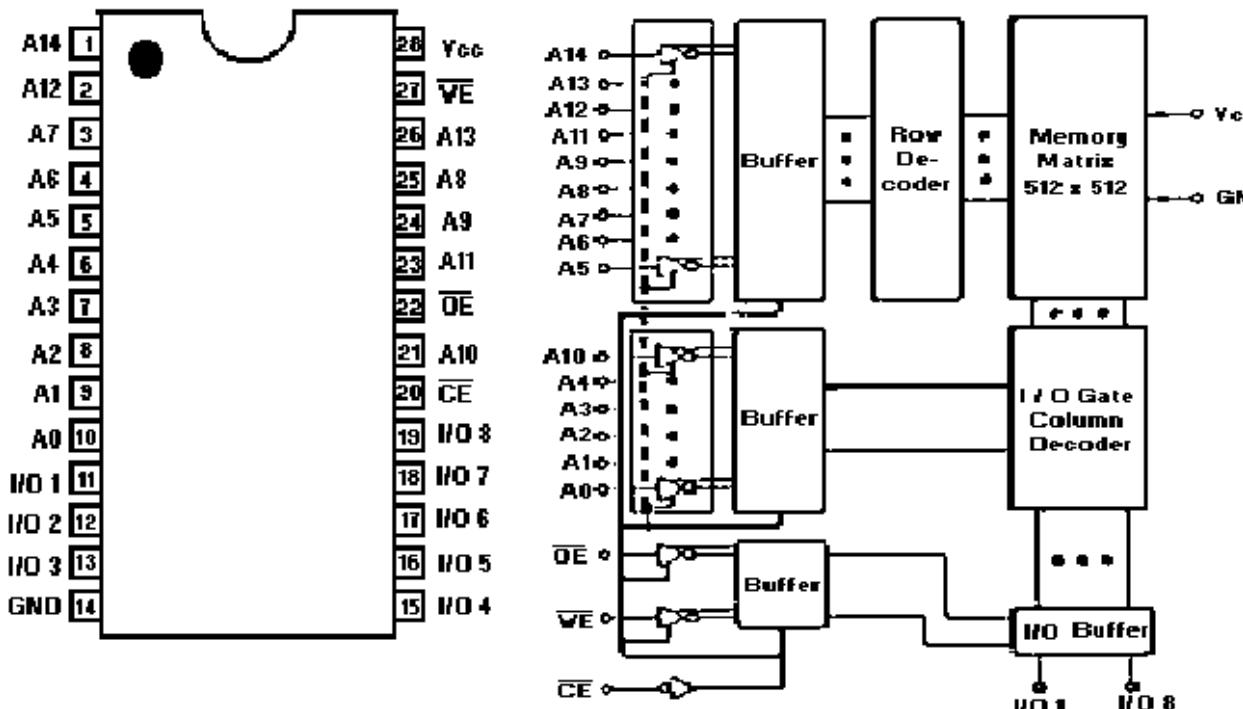
EEPROM IC708



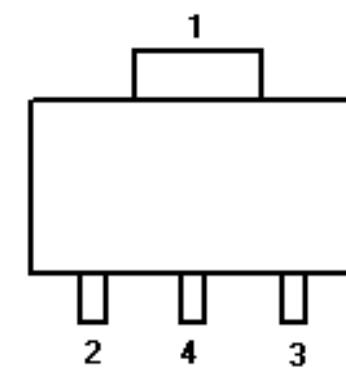
Inverter IC711



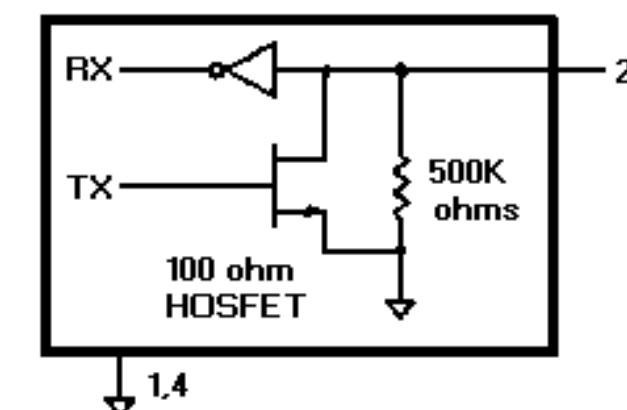
RAM IC709



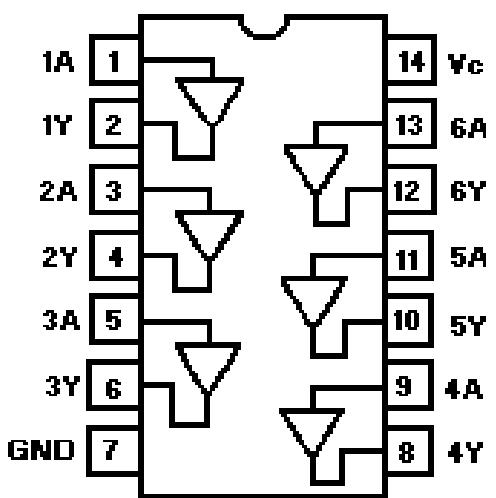
Silicon Serial Number IC712



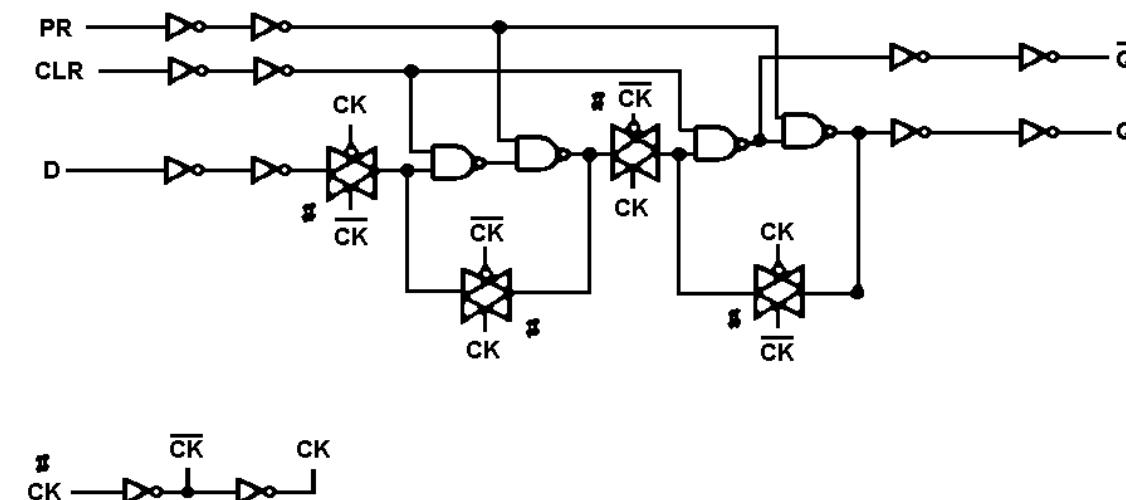
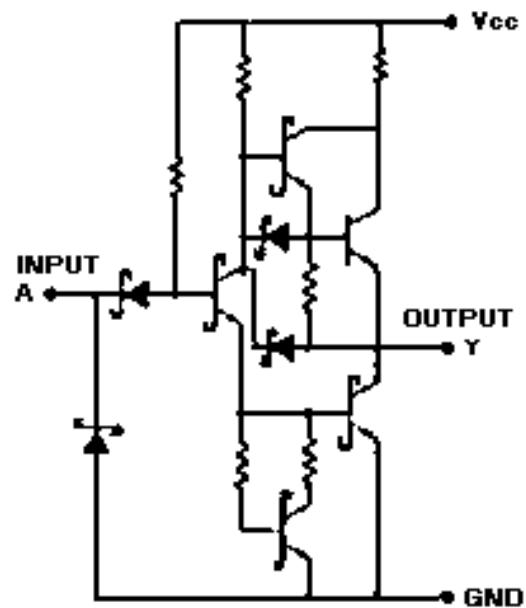
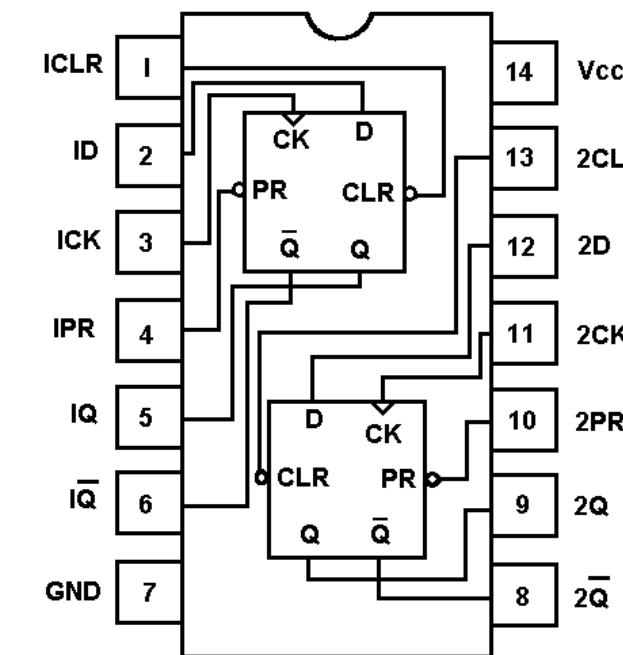
1. GND
2. DATA (DG)
3. NC
4. GND



Inverter IC713



Circuit IC714



PARTS LIST
LOGIC/IF BOARD
LOGIC SECTION
CMC-682D
(Used in P101, P102, P103)

SYMBOL	PART NO.	DESCRIPTION
C601	NOTE: Parts listed are for reference only. Refer to Service Section for serviceable parts.	CAPACITORS ----- Ceramic: 0.01 μ F ±10% 50 VDC, temp coef ±15%. Ceramic: 1 μ F +80%/-20% 16 VDCW, temp coef +22%/-82%.
C602		Ceramic: 220 pF ±5% 50 VDCW, temp coef 0±30 PPM/C
C603		Ceramic: 0.1 μ F +80%/-20% 25 VDCW. Ceramic: 0.1 μ F ±10% 50 VDC, temp coef ±15%. Tantalum: 1 μ F ±20% 16 VDCW.
C604		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C605		Tantalum: 1 μ F ±20% 16 VDCW.
C606		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C607		Tantalum: 1 μ F ±20% 16 VDCW.
C608		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C609		Tantalum: 1 μ F ±20% 16 VDCW.
C610		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C611		Tantalum: 3.3 μ F 20% 16 VDCW.
C612		Tantalum: 1 μ F ±20% 16 VDCW.
C613		Tantalum: 0.33 μ F ±20% 35 VDCW.
C614		Ceramic: 100 pF 5% 50 VDCW, temp coef 0±30 PPM/C.
C615		Ceramic: 1 μ F +80%/-20% 16 VDCW, temp coef +22%/-82%.
C616		Tantalum: 0.33 μ F ±20% 35 VDCW.
C617		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C618		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C621		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C622		Tantalum: 22 μ F ±20% 16 VDCW.
C623		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C624		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C626		Tantalum: 22 μ F ±20% 16 VDCW.
C627		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C628		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C629		Tantalum: 22 μ F ±20% 16 VDCW.
C630		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C631		Tantalum: 22 μ F ±20% 16 VDCW.
C632		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C633		Tantalum: 22 μ F ±20% 16 VDCW.
C634		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C637		Ceramic: 220 pF ±5% 50 VDCW, temp coef 0±30 PPM/C
C638		Electrolytic: 47 μ F ±20% 25 VDCW.
C639		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C640		Electrolytic: 22 μ F ±20% 16 VDCW.
C641		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C642		Electrolytic: 22 μ F ±20% 16 VDCW.
C643		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C644		Electrolytic: 10 μ F 20% 25 VDCW.
C645		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C646		Ceramic: 1000pF +80%/-20% 50 VDCW temp coef +22%/-82%.
C647		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C649		Electrolytic: 22 μ F ±20% 16 VDCW.
C650		Ceramic: 0.47 μ F +80%/-20% 25 VDCW temp coef +30%/-80%.
C651		Tantalum: 2.2 μ F ±20% 16 VDCW.
C652		Electrolytic: 10 μ F ±20% 25 VDCW.
C653		Ceramic: 0.047 μ F +80%/-20% 50 VDCW temp coef +22%/-82%.
C654		Tantalum: 1 μ F ±20% 16 VDCW.
C655		
C656		
C657		
C658		
C659		
C660		

SYMBOL	PART NO.	DESCRIPTION
C661 thru C664	NOTE: Parts listed are for reference only. Refer to Service Section for serviceable parts.	Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%. Ceramic: 0.1 μ F ±10% 25 VDCW, temp coef ±15%.
C665 and C666		Tantalum: 1 μ F ±20% 16 VDCW.
C667		Ceramic: 3300 pF ±10% 50 VDCW, temp coef 15%. Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C668 and C669		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +20%/-82%. Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C670 and C671		Ceramic: 47 pF ±5% 50 VDCW, temp coef 0±30 PPM/C. Ceramic: 12 pF ±2.5 pF 50 VDCW, temp coef 0±30 PPM/C.
C672		Ceramic: 47 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
C673		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
C674		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C701 thru C706		Ceramic: 3.3 μ F 20% 16 VDCW.
C707 and C708		Tantalum: 1 μ F ±20% 16 VDCW.
C709		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C710		Tantalum: 1 μ F ±20% 16 VDCW.
C711		Ceramic: 47 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
C712 and C713		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
C714		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C715 thru C719		Tantalum: 1 μ F ±20% 16 VDCW.
C720 and C722		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C723 and C726		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C727		Ceramic: 100 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
C728 thru C745		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C746 and C747		Ceramic: 1000 pF ±10% 50 VDCW, temp coef ±15%. Ceramic: 1000pF +80%/-20% 50 VDCW temp coef +22%/-82%.
C748		Ceramic: 470 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
C749		Ceramic: 0.1 μ F +80%/-20% 25 VDCW, temp coef +22%/-82%.
C750		Ceramic: 47 pF ±5% 50 VDCW, temp coef 0±30 PPM/C.
CD601 and CD602		POWER Supply rectification diode: sim to SANKEN SPPM-64V.
CD604 and CD605		Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS300.
CD606		Zener 900mW 22 V: sim to Hitachi HZF22.
CD701 thru CD705		Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS302.
CD709 and CD710		Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS302.
CD711		Silicon fast recovery (2 diodes in series):sim to TOSHIBA ISS300.
CX701 and CX702		EMI Filter.
F601		Fuses ----- Fuse 5A.
IC601 and IC602		INTEGRATED CIRCUITS ----- Audio Signal PROCESSOR.
IC603		Linear Audio Amplifier: sim to NJRC NJM3403AV.
IC604		AF Power Amplifier: sim to NEC UPC2500H.
IC605		Linear Positive Voltage Regulator: sim to NJRC NJM78L09UA.
IC606		Linear: Positive Voltage Regulator; sim to MOTOROLA MCT7805CT.
IC607		Linear: Positive Voltage Regulator; sim to SANYO L78M05T.
IC608		Linear: Positive Voltage Regulator; sim to SANYO L78M09T.
IC609		Linear Positive Voltage Regulator: sim to NJRC NJM78L09UA
IC610		Dual Single Supply Comparator; sim to NJRC NJM2903M

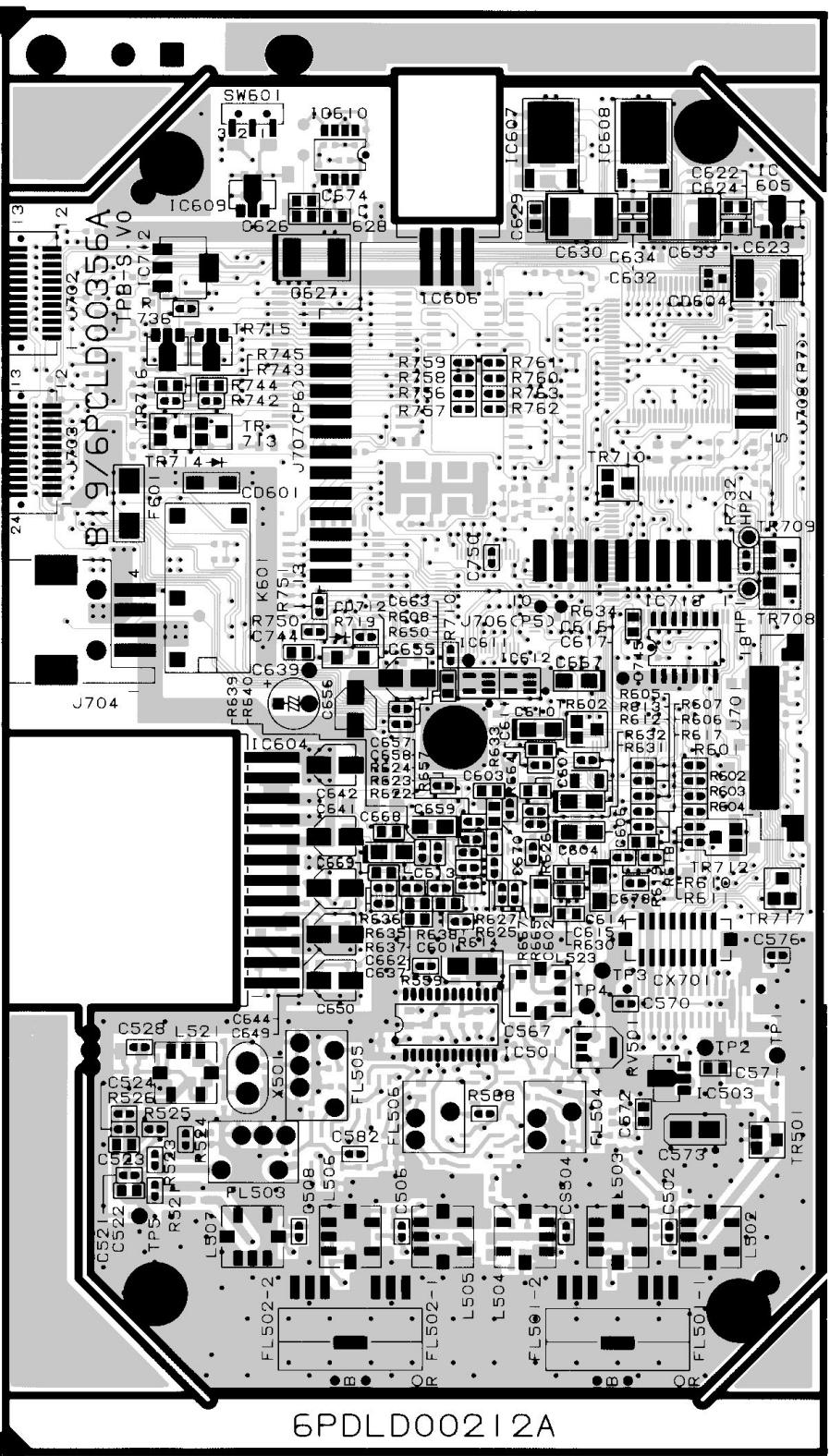
SYMBOL	PART NO.	DESCRIPTION
IC611 thru IC613	NOTE: Parts listed are for reference only. Refer to Service Section for serviceable parts.	Bilateral Switch: sim to TOSHIBA TC4S66F.
IC614		Dual Single Supply Operational Amplifier; sim to NJRC NJM3404AV.
IC701		CPU: sim to HITACHI HD6435328RC72E.
IC702		ASIC: sim to TOSHIBA TC24SC090AF.
IC703		DECODER: Sim to MOTOROLA MC74HC139.
IC704		RS485 Driver/Receiver: sim to NS AS75176.
IC705		RS232 Driver/Receiver: sim to MAXIM MA232EWE.
IC706		FLASH MEMORY: sim to AMD AM29F040.
IC707		EEPROM: sim to HITACHI HN58C66FP.
IC708		RAM: sim to TOSHIBA TC55257CFL.
IC709		Inverter: sim to MOTOROLA MC74HC04AFR.
IC711		Silicon Serial Number: sim to DALLAS DS2401Z.
IC712		Inverter: sim to HITACHI HD74LS04FP.
IC713		Dual D-type Flip Flops: sim to HITACHI HD74HC74
IC714		JACKS ----- Connector: 18 pins.
J701		Connector: 24 pins.
J702 and J703		Connector: 4 pins.
J704		Connector: 10 pins.
J706		Connector: 13 pins.
J707		Connector: 5 pins.
K601		Relay: sim to TAKAMIZAWA JY9H-K.
R601		----- RESISTORS ----- Metal film: 15K ohms ±5% 100 VDCW 1/16W.
R602		Metal film: 33K ohms ±5% 100 VDCW 1/16W.
R603		Metal film: 68K ohms ±5% 100 VDCW 1/16W.
R604		Metal film: 120K ohms ±5% 100 VDCW 1/16W.
R605		Metal film: 270K ohms ±5% 100 VDCW 1/16W.
R606		Metal film: 56K ohms ±5% 100 VDCW 1/16W.
R607		Metal film: 150K ohms ±5% 100 VDCW 1/16W.
R608 and R609		Metal film: 22K ohms ±5% 100 VDCW 1/16W.
R610 and R611		Metal film: 10k ohms ±5% 100 VDCW 1/16W.
R612 and R613		Metal film: 39K ohms ±5% 100 VDCW 1/16W.
R614		Metal film: 4.7K ohms ±5% 100 VDCW 1/16W.
R615		Metal film: 100K ohms ±5% 100 VDCW 1/16W.
R616		Metal film: 470K ohms ±5% 100 VDCW 1/16W.
R617		Metal film: 3.3M ±10% 200 VDCW 1/10W.
R618 and R619		Metal film: 100K ohms ±5% 100 VDCW 1/16W.
R620		Metal film: 47K ohms ±5% 100 VDCW 1/16W.
R621		Metal film: 22K ohms ±5% 100 VDCW 1/16W.
R622 thru R624		Metal film: 56K ohms ±5% 100 VDCW 1/16W.
R625		Metal film: 10K ohms ±5% 100 VDCW 1/16W.
R626		Metal film: 56K ohms ±5% 100 VDCW 1/16W.
R627		Metal film: 150K ohms ±5% 100 VDCW 1/16W.
R628 and R629		Metal film: 100K ohms ±5% 100 VDCW 1/16W.

PARTS LIST
LOGIC/IF BOARD
IF SECTION
CMF-138D
(Used in P101, P102, P103)

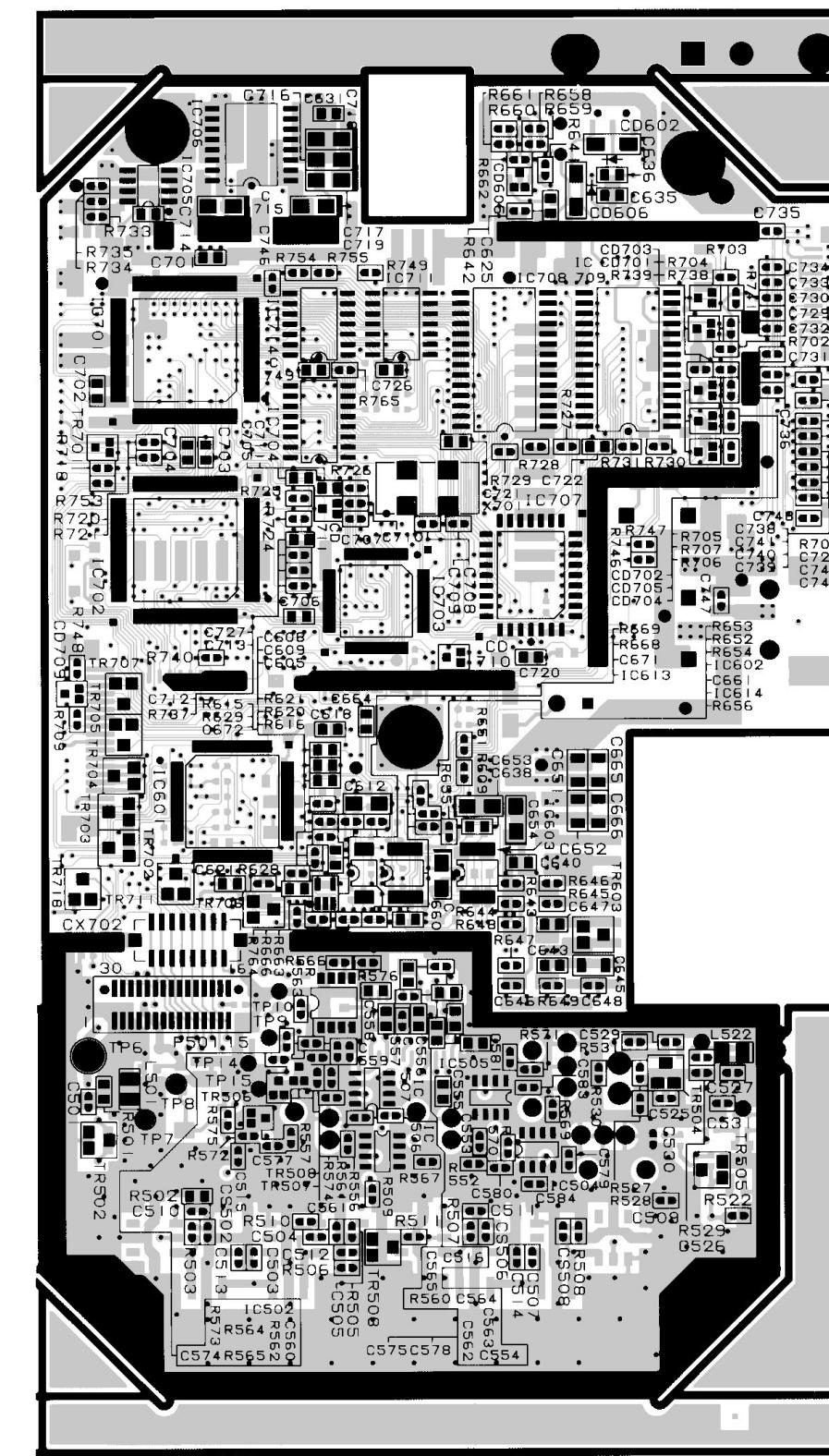
SYMBOL	PART NO.	DESCRIPTION
CAPACITORS		
C501		NOTE: Parts listed are for reference only. Refer to Service Section for serviceable parts.
C502		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C503		Ceramic: 5pF ±0.25 pF 50 VDCW temp coef 0±60 PPM.
C504		Ceramic: 1.5pF ±0.25 pF 50 VDCW temp coef 0±250 PPM.
C505		Ceramic: 7pF ±0.5 pF 50 VDCW temp coef 0±60 PPM.
C506		Ceramic: 10pF ±0.5 pF 50 VDCW temp coef 0±60 PPM.
C507		Ceramic: 5pF ±0.25 pF 50 VDCW temp coef 0±60 PPM.
C508		Ceramic: 1.5pF ±0.25 pF 50 VDCW temp coef 0±250 PPM.
C509		Ceramic: 5pF ±0.25 pF 50 VDCW temp coef 0±60 PPM.
thru		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C512		Ceramic: 0.75pF ±0.25pF 50 VDCW temp coef 0±250 PPM.
C513		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
and		
C514		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C515		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
and		
C516		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C521		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
C522		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
and		
C523		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C524		Ceramic: 15pF ±5% 50 VDCW temp coef 0±60 PPM.
C525		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C526		Ceramic: 33pF ±5% 50 VDCW temp coef 0±60 PPM.
C527		Ceramic: 18pF ±5% 50 VDCW temp coef 0±60 PPM.
C528		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C529		Ceramic: 0.01μF ±10% 50 VDCW temp coef ±15%.
C530		Ceramic: 1pF ±0.25pF 50 VDCW temp coef 0±250 PPM.
C531		Ceramic: 0.01μF ±10% 50 VDCW temp coef ±15%.
C553		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
C554		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
thru		
C556		Ceramic: 15pF ±5% 50 VDCW temp coef 0±60 PPM.
C557		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
C558		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
and		
C559		Ceramic: 0.01μF ±10% 50 VDCW temp coef ±15%.
C560		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
C561		Ceramic: 1000pF ±10% 50 VDCW temp coef ±15%.
C562		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
thru		
C565		Electrolytic: 10μF ±20% 16 VDCW.
C567		Ceramic: 0.1μF ±10% 25 VDCW temp coef ±15%.
C571		
and		
C572		Electrolytic: 10μF ±20% 16 VDCW.
C573		Ceramic: 0.01μF ±10% 50 VDCW temp coef ±15%.
thru		
C584		Tantalum: 4.7μF ±20% 16 VDCW.
C585		
FL501		
and		
FL502		
FL503		
FL504		
FL505		
FL506		
IC501		
IC502		
IC503		
IC504		
thru		
IC507		
P501		
L501		
L502		
L503		
L504		
and		
L505		
CONNECTORS		
COILS		
L501		Coil: RF 1 μH 20%.
L502		Coil: RF .
L503		Coil: RF .
L504		Coil: RF .
and		
L505		

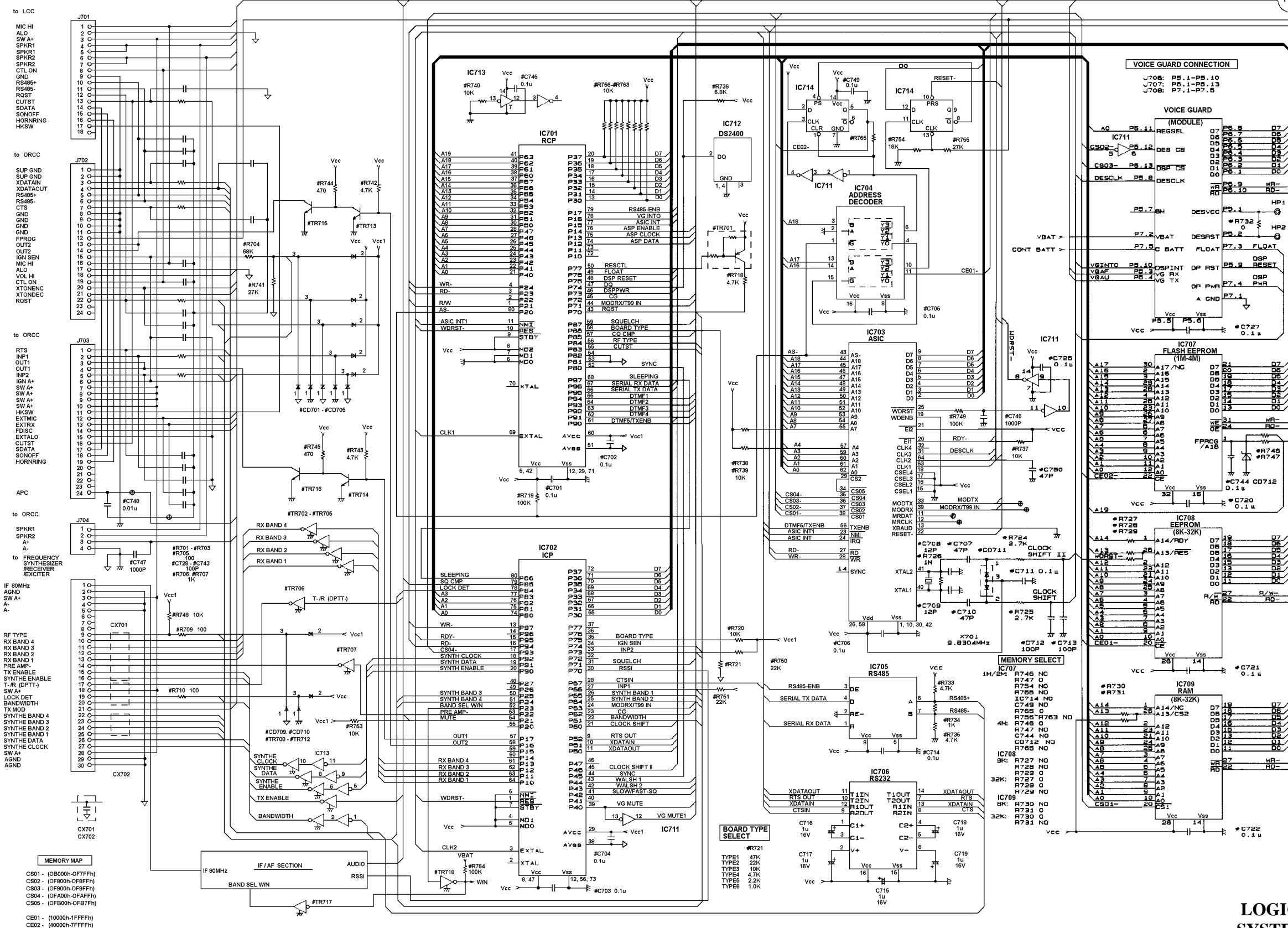
SYMBOL	PART NO.	DESCRIPTION
COILS		
L506		NOTE: Parts listed are for reference only. Refer to Service Section for serviceable parts.
L507		Coil: RF .
L521		Coil: RF .
L522		Coil: RF 0.22 μH 10%.
L523		
R501		
R502		
R503		
R505		
R506		
R507		
and		
R508		
R509		
R510		
R511		
R521		
R522		
R523		
R524		
R525		
R526		
R527		
R528		
R529		
R530		
R531		
R552		
R556		
R557		
R559		
R560		
R562		
R563		
R564		
R565		
R566		
R567		
and		
R568		
R569		
and		
R570		
R571		
R572		
and		
R573		
R574		
R575		
R721		
RV501		
TR501		
and		
TR502		
TR503		
TR504		
and		
TR505		
TR506		
thru		
TR508		
X501		
X5501A		
and		
X5501B		
RESISTORS		
L506		Coil: RF .
L507		Coil: RF .
L521		Coil: RF .
L522		Coil: RF 0.22 μH 10%.
L523		
R501		
R502		
R503		
R505		
R506		
R507		
and		
R508		
R509		
R510		
R511		
R521		
R522		
R523		
R524		
R525		
R526		
R527		
R528		
R529		
R530		
R531		
R552		
R556		
R557		
R559		
R560		
R562		
R563		
R564		
R565		
R566		
R567		
and		
R568		
R569		
and		
R570		
R571		
R572		
and		
R573		
R574		
R575		
R721		
RV501		
TR501		
and		
TR502		
TR503		
TR504		
and		
TR505		
TR506		
thru		
TR508		
X501		
X5501A		
and		
X5501B		
TRANSISTORS		
N-Channel, field effect; sim to SONY 2SK1577.		
Silicon, NPN; sim to NEC 2SC2223.		
Silicon, NPN; sim to HITACHI 2SC2620.		
Silicon, NPN, Includes Resistors; sim to TOSHIBA RN1304.		
CRYSTALS		
Quartz crystal: 82.655 MHz.		
Crystal Socket.		

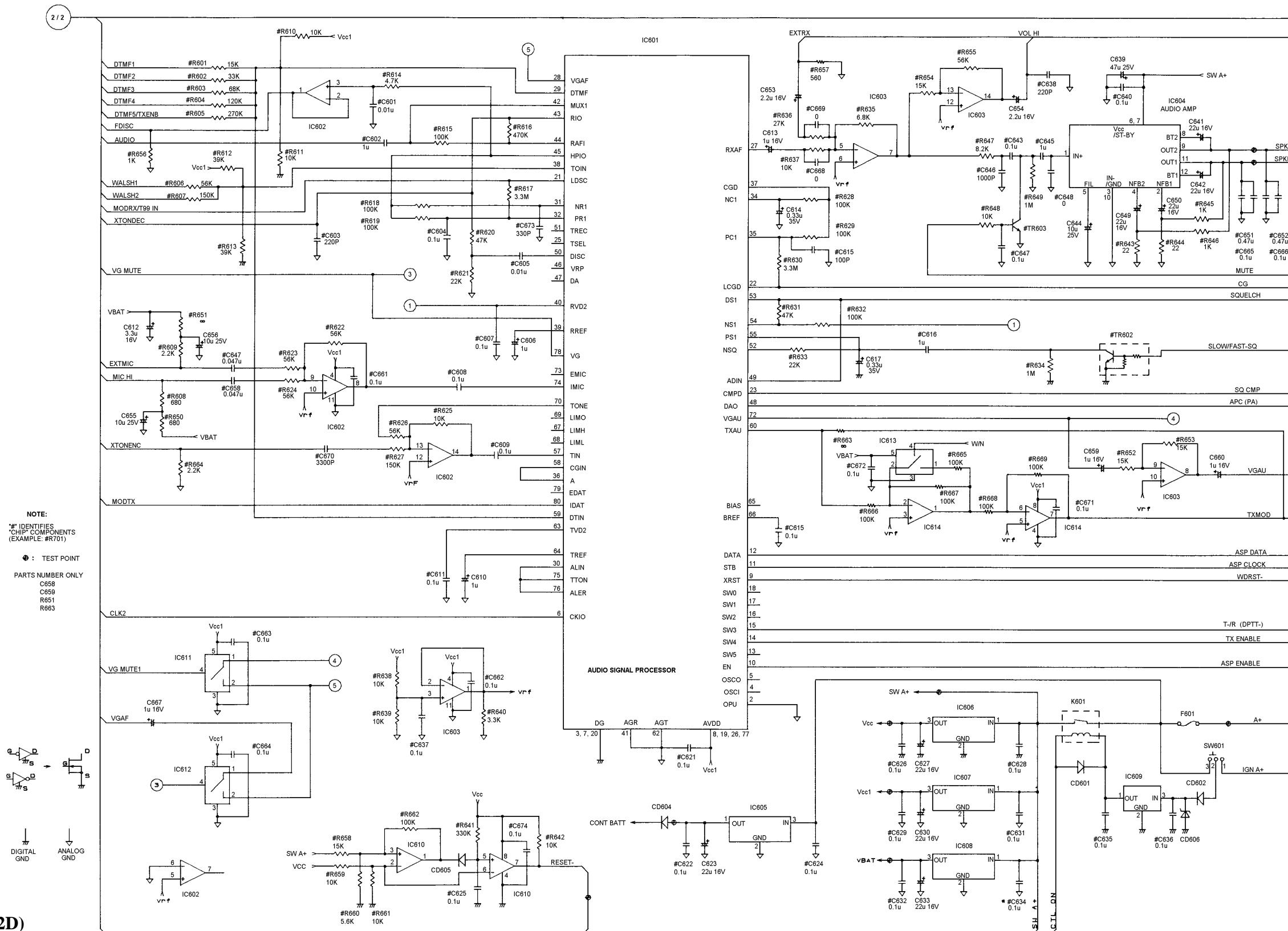
COMPONENT SIDE

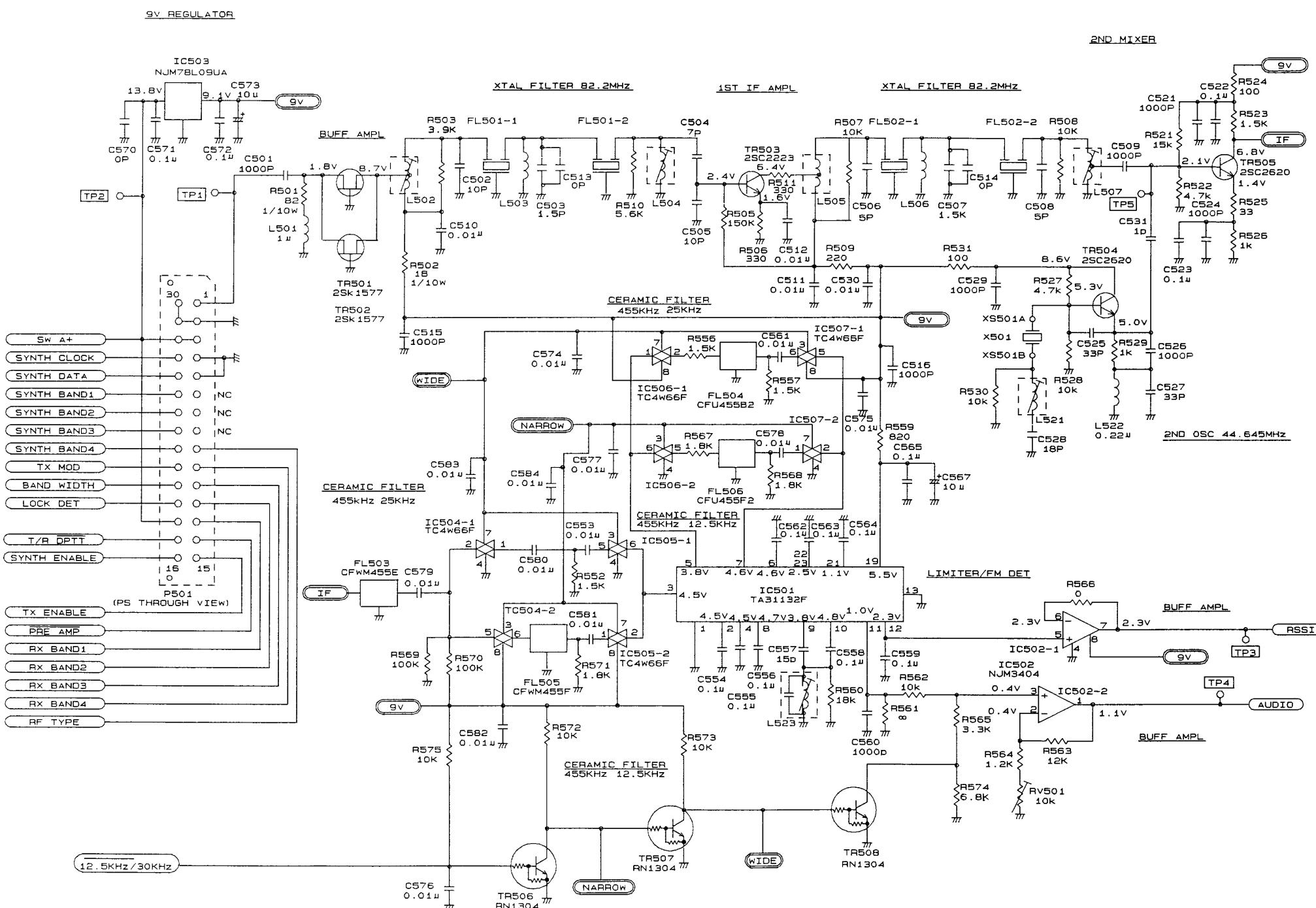


SOLDER SIDE



LOGIC (CMC-682D)
SYSTEM CONTROL



NOTE

ALL RESISTOR ARE 1/16 WATT UNLESS OTHERWISE SPECIFIED.
RESISTOR VALUES IN Ω UNLESS FOLLOWED BY MULTIPLIER K OR M.
CAPACITOR VALUES IN F UNLESS FOLLOWED BY MULTIPLIER μ .n OR p.
INDUCTANCE VALUES IN H UNLESS FOLLOWED BY MULTIPLIER m. μ OR n.

IF(CMF-138D)

(DD0-CMF-138D)